



Product Change Notification

Change Notification #: 118982-00
Change Title: Intel® Server System R1208WFQYSR and Intel® Server System R1208WF0YSR, PCN 118982-00, Product Material, Product Design, Adding second source for Voltage Regulator Controller, Alternate PBA to support Interposer and Gasket implementation in 2.5" tool less carrier
Date of Publication: March 24, 2022

Key Characteristics of the Change:

Product Material, Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	April 08, 2022
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the items listed in the "Products Affected" table.

- Adding a second source for a Voltage Regulator (VR) controller on the Hot swap backplanes (HSBP). The new controller is identical in function to the previous one but differs in form factor. As a result, we are adding as alternate the following PBA in the Hot swap backplane: H88382-401.
- Using the interposer PCB supporting a new Programmable System-On-Chip (PSOC) and the second source for a Voltage Regulatory Controller, we have the following PBA: H88382-411 being added as alternate. The new components have passed all functional and electrical validation tests successfully.
- A gasket has been added on each side of the 2.5" tool less carrier (TLC), improving the flow of electricity.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R1208WF0YSR	R1208WF0YSR	986058	K40020-005	H88382-351 H88382-352	K40020-006	H88382-351 H88382-352 H88382-401 H88382-411
Intel® Server System R1208WFQYSR	R1208WFQYSR	986059	K40302-011	H88382-351 H88382-352	K40302-012	H88382-351 H88382-352 H88382-401 H88382-411

PCN Revision History:

Date of Revision:

March 24, 2022

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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